

# BIPOLAR ANALOG INTEGRATED CIRCUIT $\mu PC8001$

# IF AMPLIFIER IC WITH ON-CHIP MIXER FOR DIGITAL CELLULAR PHONES

The  $\mu$ PC8001 is a 3-volt IF amplifier IC with an on-chip mixer developed for digital cellular phones.

The  $\mu$ PC8001 consists of a high-sensitivity limiter amplifier with an input frequency of 455 kHz, a high-speed and high-precision linear RSSI (received signal strength indicator), and a second mixer with an input frequency of 80 to 150 MHz.

The  $\mu$ PC8001 features a low 3 mA (TYP.) and 2.2  $\mu$ A (TYP.) current consumption at normal operation and power-OFF, respectively. Its high-speed charge/discharge circuit enables fast power-ON/OFF switching.

The  $\mu$ PC8001 boasts an extremely small size packaged in a 14-pin plastic shrink SOP, and low external capacitances of less than 0.01  $\mu$ F, in addition to an on-chip RSSI output resistor, and is most suitable for high-density mounting.

# FEATURES

- Low-voltage operation...3 V ±10%
- Low power consumption...(Vcc = 3 V)

|                  | Mixer IF amp. + R |                |  |
|------------------|-------------------|----------------|--|
| During operation | 2.1 mA (TYP.)     | 0.95 mA (TYP.) |  |
| At power-OFF     | 0 μA (TYP.)       | 2.2 μA (TYP.)  |  |

- High limiting sensitivity...-91 dBm (TYP.)
- High-precision RSSI linearity...±0.5 dB (TYP.) (VIF IN = -86 to -6 dBm)
- High-speed RSSI response time

| RSSI output rise time | 77μs (TYP.)   |  |  |
|-----------------------|---------------|--|--|
| RSSI output fall time | 113 μs (TYP.) |  |  |

· High-speed power-ON/OFF switching time

| Rise time at power-ON  | 174 μs (TYP.) |
|------------------------|---------------|
| Fall time at power-OFF | 3 μs (TYP.)   |

- External capacitors of less than 0.01  $\mu$ F
- On-chip RSSI output resistor (34 k $\Omega$ )
- Ultra-compact package...14-pin plastic shrink SOP

The information in this document is subject to change without notice.

# ORDERING INFORMATION

| Part number   | Package  |  |  |
|---|--|--|--|
| μPC8001GR   | 14-pin plastic shrink SOP (225 mil)  |  |  |
| μPC8001GR-E1 14-pin plastic shrink SOP (225 mil)<br>μPC8001GR-E1 Embossed carrier taping (Pin 1 located toward tape und<br>direction) |  |  |  |
| μPC8001GR-E2  | 14-pin plastic shrink SOP (225 mil)<br>Embossed carrier taping (Pin 1 located toward tape wind<br>direction) |  |  |

# **BLOCK DIAGRAM**



Note Input/output impedance of 455 kHz BPF: 1.5 k  $\Omega$ 

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#### PIN CONFIGURATION AND PIN FUNCTIONS 1.

#### PIN CONFIGURATION (Top View) (1)

• 14-pin plastic shrink SOP (225 mil)



: Oscillator Input PD

: Power Down

**RSSI OUT** : Received Signal Strength Indicator Output

VCC1, VCC2 : Power Supply

# (2) PIN FUNCTIONS

| Number | Pin Name | I/O | Function  |
|--------|----------|-----|---|
| 1      | IF OUT   | 0   | IF amplifier output   |
| 2      | PD       | I   | Power-ON/OFF control signal input<br>High level: Power-ON; Low level: Power-OFF |
| 3      | PSSI OUT | 0   | RSSI output   |
| 4      | FIL3     | _   | Connect capacitor for filter.   |
| 5      | Vcc2     | _   | IF amplifier and RSSI power pin   |
| 6      | IF IN    | I   | IF amplifier input  |
| 7      | FIL1     | _   | Connect capacitor for filter.   |
| 8      | FIL2     | _   | Connect capacitor for filter.   |
| 9      | MIX OUT  | 0   | Mixer output  |
| 10     | GND      | _   | Ground pin  |
| 11     | OSC IN   | I   | Oscillator input  |
| 12     | Vcc1     | _   | Mixer power pin   |
| 13     | MIX IN2  | I   | Connect capacitor for filter.   |
| 14     | MIX IN1  |     | Mixer input   |

# 2. I/O EQUIVALENT CIRCUIT



# 3. ELECTRICAL SPECIFICATIONS

# Absolute Maximum Ratings (T<sub>A</sub> = 25°C)

| Parameter                     | Symbol | Conditions | Rating      | Unit |
|-------------------------------|--------|------------|-------------|------|
| Supply voltage                | Vcc    |            | 7           | V    |
| Total power dissipation       | Рт     |            | 300         | mW   |
| Operating ambient temperature | TA     |            | -30 to +85  | °C   |
| Storage temperature           | Tstg   |            | -40 to +125 | °C   |

Caution Exposure to Absolute Maximum Ratings for extended periods may affect device reliability; exceeding the ratings could cause permanent damage. The parameters apply independently. The device should be operated within the limits specified under DC and AC Characteristics.

# Recommended Operating Conditions (T<sub>A</sub> = 25°C)

| Parameter                    | Symbol   | Conditions      |                         | MIN.                  | TYP. | MAX.                 | Unit                 |
|------------------------------|----------|-----------------|-------------------------|-----------------------|------|----------------------|----------------------|
| Supply voltage               | Vcc      |                 |                         | 2.7                   | 3.0  | 3.3                  | V                    |
| Mixer input level            |          | See Figure 3-1  | 50 $\Omega$ termination | -100                  |      | -20                  | dBm <sup>Note1</sup> |
|                              |          | See Figure 5-1. | LC matching             | -113 <sup>Note2</sup> |      | -33 <sup>Note2</sup> | dBm <sup>Note1</sup> |
| IF amplifier input level     | Vif in   |                 |                         | -86                   |      | -6                   | dBm <sup>Note1</sup> |
| Oscillator input level       | Vosc IN  |                 |                         | -30                   | -15  | -5                   | dBm <sup>Note1</sup> |
| IF amplifier input frequency | fif in   |                 |                         | 400                   | 455  | 500                  | kHz                  |
| Mixer input frequency        | fmix in  |                 |                         | 80                    | 130  | 150                  | MHz                  |
| Mixer output frequency       | fмix out |                 |                         | 400                   | 455  | 500                  | kHz                  |

Notes 1. Assuming a conversion value of 50  $\Omega$ , 0 dBm = 0.2236 Vrms.

2. Depends on board wiring pattern, use as reference value.

# **ELECTRICAL CHARACTERISTICS**

 $(T_{A} = 25^{\circ}C, V_{CC1} = V_{CC2} = 3 \text{ V}, \text{ fmix in} = 130 \text{ MHz}, \text{ fosc in} = 129.545 \text{ MHz}, \text{ fif in} = 455 \text{ kHz}, C_{RS} = 1000 \text{ pF}, C_{OS} = C_{M1} = C_{M2} = C_{M0} = C_{IF} = C_{FL1} = C_{FL2} = C_{FL3} = 0.01 \mu \text{F}, 0 \text{ dBm} = 0.2236 \text{ V}_{rms})$ 

# (1) Mixer

| Parameter                     | Symbol          | Conditions                           |                         | MIN. | TYP.                 | MAX. | Unit |
|-------------------------------|-----------------|--------------------------------------|-------------------------|------|----------------------|------|------|
| Supply current                | Icc1            | No signal                            |                         |      | 2.1                  | 3.0  | mA   |
|                               |                 | $V_{\text{MIN IN}} = -50 \text{dBm}$ | 50 $\Omega$ termination | 15   | 20                   | 23   | dB   |
|                               |                 | See Figure 3-1.                      | LC matching             |      | 33 <sup>Note 1</sup> |      |      |
| Third order intercept         | IC <sub>3</sub> | See Figure 3-2.                      |                         | -13  | -8                   |      | dBm  |
| -1dB compression output level | VOMIX           | Vosc IN=-15dBm                       |                         | -5   | 0                    |      | dBm  |
|                               |                 | See Figure 3-3.                      |                         | 5    | 0                    |      |      |
| Cut-off frequency             | fc              | -3 dB point                          |                         | 200  | 470                  |      | MHz  |
| Noise figure                  | NF              | See Figure 3-6.                      |                         |      | 10 <sup>Note 1</sup> |      | dB   |
| Local isolation               | IS∟             |                                      |                         | 20   | 26                   |      | dB   |
| Mixer input impedance         | Ζім             |                                      |                         |      | 48-j383              |      | Ω    |
| Local input impedance         | ZIL             |                                      |                         |      | 80-j425              |      | Ω    |
| Output resistance             | Rом             |                                      |                         | 60   | 120                  | 180  | Ω    |
| Dower ON rise time Note2      | town            | Von = 3 V                            |                         |      | 22                   | 600  | us   |
|                               | LONIM           | Rise time of PD sig                  | gnal : 10 ns            |      | 55                   | 000  | μs   |
| Dower OFE fall time Note3     | toru            | Vof = 0 V                            |                         |      | 2                    | 200  | us   |
|                               | LOFIM           | Fall time of PD signal : 10 ns       |                         |      | 5                    | 200  | μs   |
| Power-OFF supply current      | ILM             | Vof = 0 V                            |                         |      | 0                    | 10   | μA   |

Notes 1. Depends on board wiring pattern, use as reference value.

- 2. Time until DC voltage of mixer output reaches  $\pm 10\%$  of power-ON value.
- 3. Time until supply current reaches 10% of power-ON value.

# (2) Power-ON/OFF

| Parameter               | Symbol | Conditions                       | MIN. | TYP. | MAX. | Unit |
|-------------------------|--------|----------------------------------|------|------|------|------|
| Power-ON input voltage  | Von    | Power-ON over Von and under Vcc  |      | 1.2  | 2.4  | V    |
| Power-OFF input voltage | Vof    | Power-OFF over GND and under VoF | 0.6  | 1.2  |      | V    |
| Power-ON input current  | Ιον    | Von = 3 V                        |      | 48   | 75   | μA   |

# (3) IF Amplifier/RSSI

| Parameter                           | Symbol          | Conditio   | ons        | MIN. | TYP. | MAX. | Unit              |
|-------------------------------------|-----------------|--|------------|------|------|------|-------------------|
| Supply current                      | Icc2            | No signal  |            |      | 0.95 | 1.3  | mA                |
| IF amplifier output amplitude       | Vo              | $V_{IF IN} = -20 \text{ dBm}$  |            | 1.2  | 1.5  | 1.8  | V <sub>p-p</sub>  |
| Limiting sensitivity                | LS              | -3dB point, see Figur  | e 4-5.     |      | -91  | -86  | dBm               |
| IF amplifier input impedance        | Zin             |  |            | 1.2  | 1.5  | 1.8  | kΩ                |
| IF amplifier phase variation        | $\Delta \phi$   | V <sub>IF IN</sub> =-86 to -6 dBm<br>See <b>Figure 4-6</b> <sup>Note1</sup> .            |            |      | 11   |      | deg               |
| RSSI linearity                      | Lrs             | $V_{IF IN} = -86$ to $-6$ dBm<br>Recursive calculation<br>with $V_{IF IN} = -60$ to $-6$ | dBm        |      | ±0.5 | ±2   | dB                |
| RSSI slope                          | SLrs            | Recursive calculation<br>with VIF IN = $-60$ to $-6$                                     | dBm        | 22.3 | 24.4 | 30.1 | mV/dB             |
| RSSI intercept                      | ICrs            | Recursive calculation<br>with VIF IN = −60 to −6 dBm<br>See <b>Figure 3-4</b> .          |            | -135 | -118 | -104 | dBm               |
| RSSI output voltage1                | V <sub>R1</sub> | $V_{IF IN} = -86 \text{ dBm}$  |            | 0.50 | 0.79 | 0.98 | V                 |
| RSSI output voltage 2               | V <sub>R2</sub> | $V_{IF IN} = -46 \text{ dBm}$  |            | 1.60 | 1.79 | 1.90 | v                 |
| RSSI output voltage 3               | V <sub>R3</sub> | $V_{IF IN} = -6 \text{ dBm}$   |            | 2.70 | 2.75 | 2.82 | V                 |
| RSSI output temperature stability   | S⊤              | $V_{IF IN} = -86 \text{ to } -6 \text{ dBm}$<br>$T_A = -30 \text{ to } +85 \text{ °C}$   | 1          |      | 1    |      | dB                |
| RSSI rise time                      | trRS            | V⊮   |            |      | 77   | 300  | μs                |
| RSSI fall time                      | trrs            | V⊮ IN = −6 dBm<br>See <b>Figure 3-5</b> .  |            |      | 113  | 300  | μs                |
| RSSI output ripple                  | Vrrs            | $V_{IF IN} = -6 \text{ dBm}$   |            |      | 3    | 12   | mV <sub>p-p</sub> |
| Power-OFF supply current            | lu              | $V_{OF} = 0 V$   |            |      | 2.2  | 10   | μA                |
| Power-ON rise time <sup>Note2</sup> | toni            | $V_{ON} = 3 V$ , $V_{IF IN} = -86 dBm$<br>PD signal rise time: 10 ns                     |            |      | 174  | 600  | μs                |
| Power-OFF fall time Note3           | tofi            | V <sub>OF</sub> = 0 V<br>PD signal fall time: 10 ns                                      |            |      | 3    | 200  | μs                |
| IF amplifier output slew rate       | SRo             | VIEIN20 dBm  | Rise Note4 |      | 3.4  |      | Mura              |
|                                     |                 |  | Fall Note5 |      | 3.8  |      | viμs              |
| RSSI output resistance              | Ror             |  |            | 27   | 34   | 41   | kΩ                |

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Notes 1. Use the network analyzer at RBW = 3 Hz.

- 2. Time until RSSI output reaches  $\pm 10\%$  of power-ON value.
- **3**. Time until supply current reaches 10% of power-ON value.
- 4. Rise: 10% to 90%
- 5. Fall: 90% to 10%

# Figure 3-1. Mixer Input



Note The values L and C are affected by the parasitic capacitance and inductance of the board. Therefore, adjust L and C so that the impedance at the MIX IN pin from the signal source equals  $50\Omega$ .

**Remark** The signal source impedance is  $50\Omega$ .



# Figure 3-2. Third Order Intercept

 $\label{eq:Remark} \textbf{Remark} \quad \text{Signal source impedance is } 50 \Omega.$ 

# NEC

# Figure 3-3. -1 dB Compression Output Level





Figure 3-5. RSSI Response Time







The noise figure is calculated as follows:

 $NF = ENR - 10 \log (Y - 1)$ 

NF (dB): Noise figure ENR (dB): ENR of noise source

Y: Y = 
$$10^{\frac{N_2 - N_1}{10}}$$

N1 (dBm): Spectrum analyzer indication value at SW OFF.

N2 (dBm): Spectrum analyzer indication value at SW ON.

Remark This measurement measures DSB. To measure SSB, add 3 dB to NF above.

# 4. CHARACTERISTIC CURVES



Figure 4-1. Mixer Supply Current vs. Supply Voltage









Figure 4-4. IF Amplifier/RSSI Supply Current vs. Supply Voltage





Figure 4-5. IF Amplifier Output Level vs. IF Amplifier Input Level







Figure 4-7. RSSI Output Voltage vs. IF Amplifier Input Level (The temperature characteristics curves)



# ★ 5. TEST CIRCUIT EXAMPLE



- **Note** The value of the capacitance connected to the IF OUT pin (No. 1) includes the capacitances of PCB wiring patterns and the tester.
- **Remark** In three cases of Mixer Input, Third Order Intercept and Noise Figure Measurement, refer to Figures 3-1, 3-2, and 3-6.

# 6. PACKAGE DRAWINGS

# 14 PIN PLASTIC SHRINK SOP (225 mil)





detail of lead end





### ΝΟΤΕ

Each lead centerline is located within 0.10 mm (0.004 inch) of its true position (T.P.) at maximum material condition.

|      |                        | P14GM-65-225B-2       |
|------|------------------------|-----------------------|
| ITEM | MILLIMETERS            | INCHES                |
| А    | 5.40 MAX.              | 0.213 MAX.            |
| В    | 0.75 MAX.              | 0.030 MAX.            |
| С    | 0.65 (T.P.)            | 0.026 (T.P.)          |
| D    | 0.30+0.10              | 0.012+0.004<br>-0.003 |
| E    | 0.125±0.075            | 0.005±0.003           |
| F    | 1.8 MAX.               | 0.071MAX.             |
| G    | 1.44                   | 0.057                 |
| Н    | 6.2±0.3                | 0.244±0.012           |
| I    | 4.4                    | 0.173                 |
| J    | 0.9                    | 0.035                 |
| К    | $0.15^{+0.10}_{-0.05}$ | 0.006+0.004           |
| L    | 0.5±0.2                | 0.020+0.008           |
| Μ    | 0.10                   | 0.004                 |
| N    | 0.10                   | 0.004                 |

# 7. RECOMMENDED SOLDERING CONDITIONS

The following conditions must be met for soldering conditions of the  $\mu$ PC8001. For more details, refer to our document "SEMICONDUCTOR DEVICE MOUNTING TECHNOLOGY MANUAL" (IEI-1207).

Please consolt with our sales offices in case other soldering process is used, or in case the soldering is done under different conditions.

# Types of Surface Mount Device

# µPC8001GR: 14-pin plastic shrink SOP (225 mil)

| Soldedering process    | Soldering conditions  | Symbol     |
|------------------------|---|------------|
| Infrared ray reflow    | <ul> <li>Peak temperature of package surface: 235 °C or below,</li> <li>Reflow time: 30 seconds or below (210 °C or higher),</li> <li>Number of reflow processes: MAX. 2</li> <li>[Remark]</li> <li>(1) Please start the second reflow process after the temperature, raised by the first reflow process, returns to normal.</li> <li>(2) Please avoid removing the residual flux with water after the first reflow process.</li> </ul> | IR35-107-2 |
| Partial heating method | Terminal temperature: 300 °C or below,<br>Time: 3 seconds or below (Per one side of the device).  |            |

# **Precautions Against Static Electricity**

Caution When handling the device, be careful to protect it from static electricity. exposure to a strong static electricity charge may destroy internal transistor junctions. During transportation and storage, place the device in the conductive tray or case originally provided by NEC for shipping, or conductive shock absorbing material, metal case, etc. During assembly, be sure to ground the device. Be careful not to place the device on a plastic board and do not touch the device's pins.

[MEMO]

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